



Developing a Robust 3D Representation Framework for 3D Printed Materials



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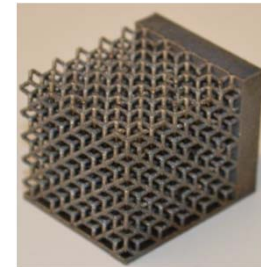
Integrity ★ Service ★ Excellence



Background



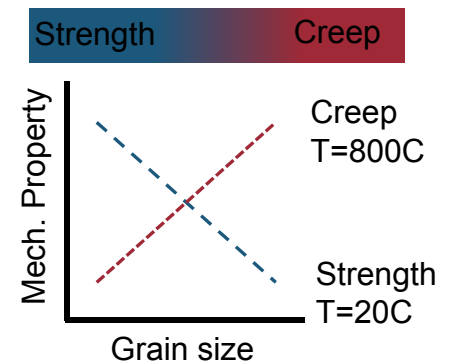
- Potential benefits of AM include:
 - Rapid turn-around & short lead times
 - Component complexity enabler for topology optimized, organic, & lattice structures
 - Tailored or graded performance & properties, competing requirements



Form – Fit – Function

- Additive manufacturing (a.k.a. AM, 3D Printing) grew from rapid prototyping – *form and fit* were initial focus
- Use of AM in service requires getting *function* right

Structural applications have stringent requirements on *function*

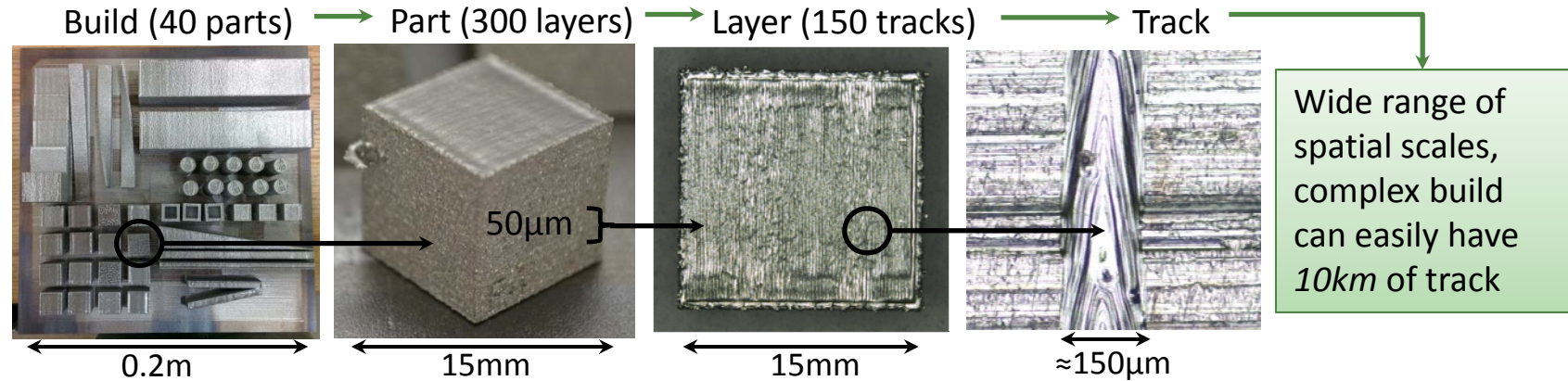




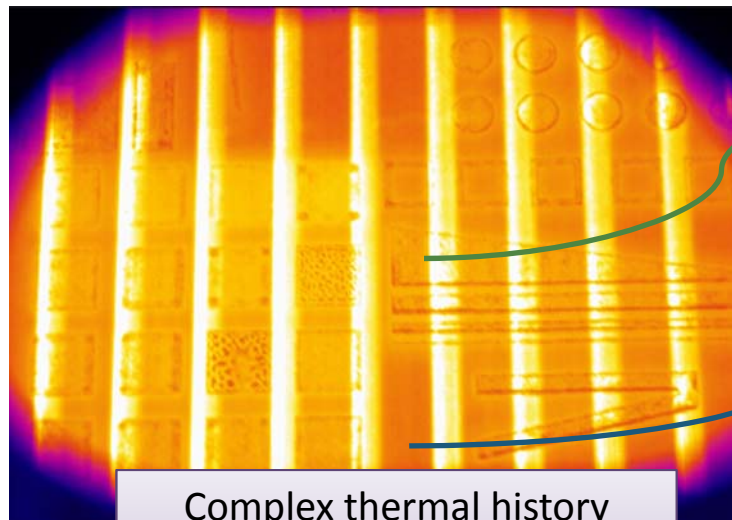
Powder Bed Fusion of Metals



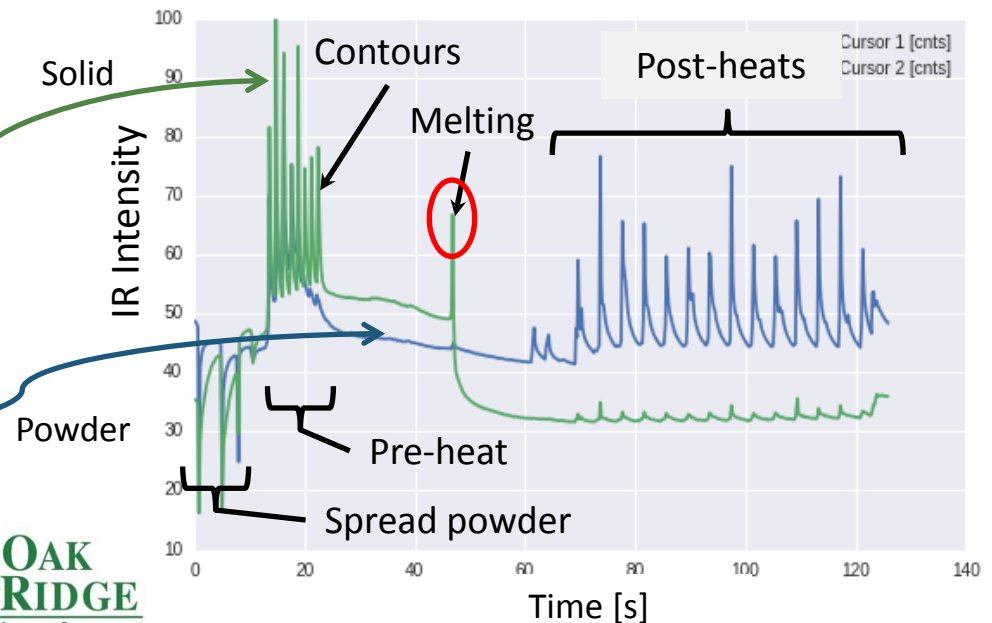
Spatial



Temporal



Complex thermal history
Solidification event $\approx 1\ \mu\text{s}$
Full build $\approx 1\ \text{day}$



AM is spatially and temporally complex



Materials Science Primer



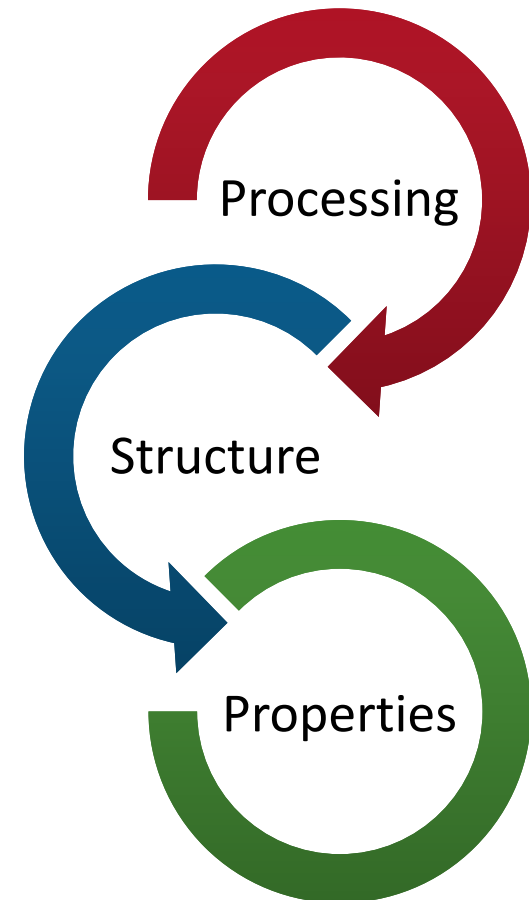
- Core Concept:

Processing – Structures – Properties (PSP)

- Performance & properties are dictated by (micro)structure, e.g.: $\text{strength} \propto \text{size}^{-\frac{1}{2}}$
- Structure is controlled by processing history/pathway:
 $\text{size} = f(\text{cooling rate})$

- Materials *engineering* – manipulate processing pathway to obtain desirable structure and therefore performance

AM provides unique opportunity to *locally influence* this chain of relationships

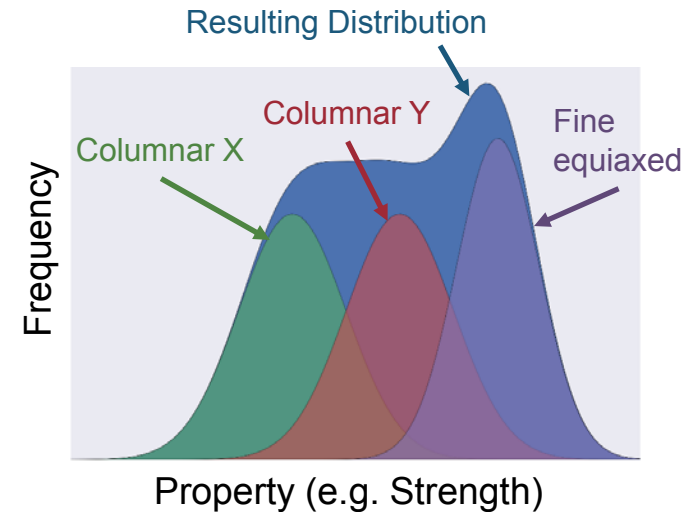
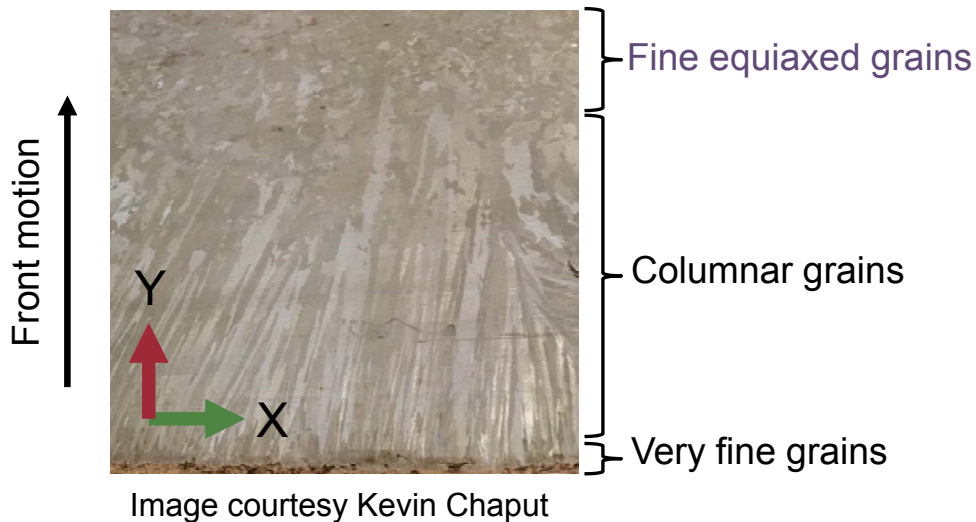




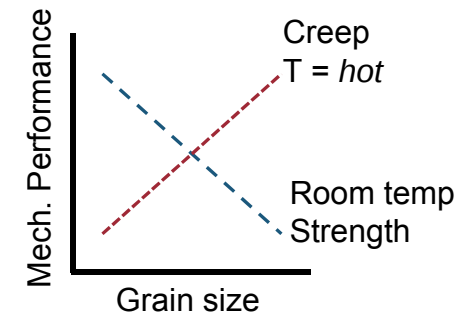
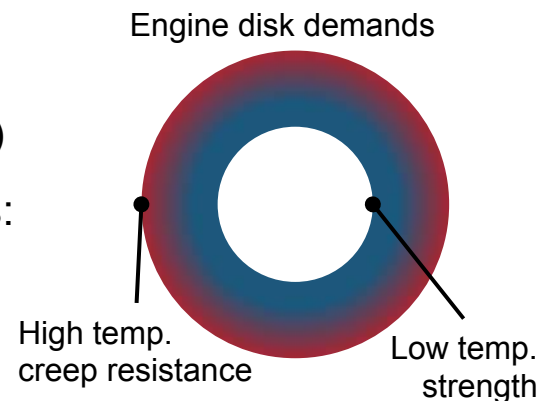
Heterogeneous Nature of Materials



Conventional Cast Structure



- Heterogeneity & anisotropy are “the norm”
- Can be desirable! (extra degree of freedom)
- However, with most *conventional* processes:
 - Tightly *coupled* to part geometry
 - Influenced by *global* process parameters
 - Little/no *site-specific* control



AM can *relax* (not eliminate) these constraints

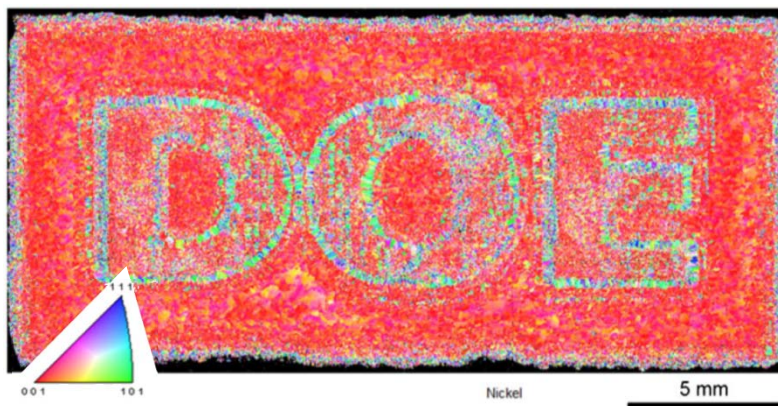


Site Specific (for Better or Worse)



Purposeful or Explicit

IN718 (Nickel) *electron beam powder bed*
Careful manipulation of process sequence
(and thus thermal history) to achieve
grain size & orientation control



Site specific control of crystallographic grain
orientation through electron beam additive
manufacturing

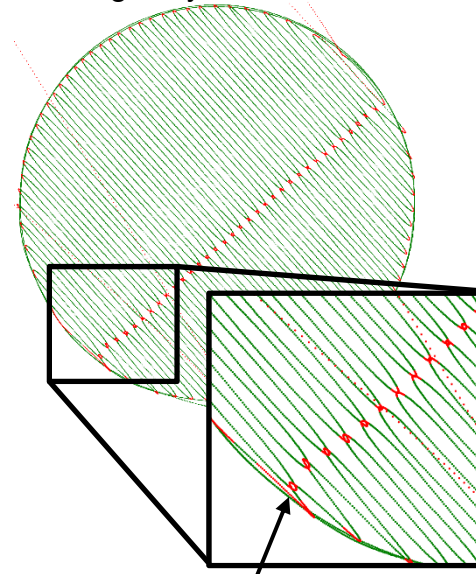
R. R. Dehoff^{1,2}, M. M. Kirka^{1,2}, W. J. Sames^{1,3}, H. Bilheux⁴, A. S. Tremsin⁵,
L. E. Lowe^{1,2} and S. S. Babu^{1,6,7}

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Unintended or Implicit

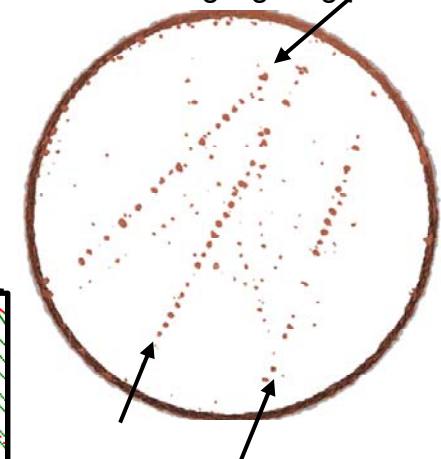
Ti-6Al-4V (Titanium) cylinder – *laser powder bed*
Interaction of complex scan strategy and part
geometry introduces 'artificial' inhomogeneity,
Defects frequency varies spatially in accordance

Measured scan path –
single layer



Beam off at internal boundary

X-ray CT data
1mm slab highlighting pores



Cylinder diam.=10mm
Typical pore 100µm

AM is site-specific in both purposeful & unintended fashions (typically both!)



Aerospace Design Practice

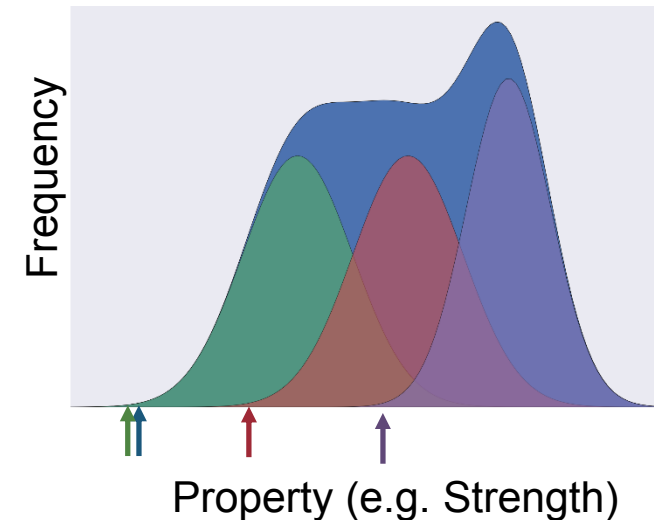


- Mechanical design accounts for 'worst case' behavior, property mins.
- *Accepted properties* for aerospace materials from "Metallic Materials Properties Development and Standardization" handbook (MMPDS)
 - A-basis: 99% of pop. exceeds w/ 95% confidence
 - B-basis: 90% of pop. exceeds w/ 95% confidence
- Expensive to generate sufficient test data, design with handbook data to avoid case-by-case qual.

(maintained by Battelle Memorial Institute for FAA, DoD)

Example data header for Ti-6Al-4V

Processing	Specification	AMS 4911 [®]					
Proc. & Geo.	Form	Sheet		Plate			
Processing	Condition	Annealed					
Geometry	Thickness, in.	≤ 0.1874		0.1875-2.000		2.001-4.000	
	Basis	A	B	A	B	A	B



Break out sub-populations

AM Challenge: coupling between site-specific processing & complex geometries → SOA for AM is point design



Recap



- What have we established?

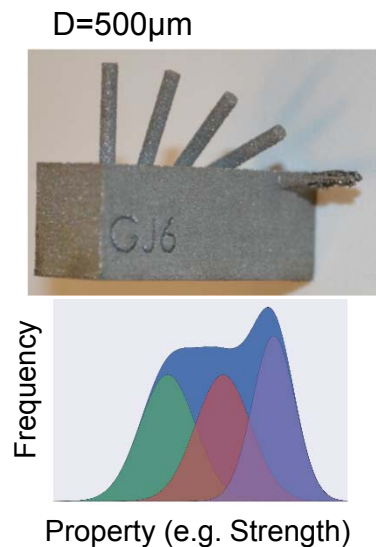
- Process – structure – properties relationships critical to ensure *function*
- Process varies spatially in 3D
- Variation can be explicit, implicit, *or likely both*

- Where do we want to be?

- Routinely exploit PSP relationships during design of complex parts (think “AM process sensitive Top.Opt.”)
- Be sensitive to qualification processes/requirements

- What do we need to get there?

- A robust 3D framework to capture/describe PSP:
 - **Intent/planning** information: location specific conditions
 - **Execution record**: in-situ monitoring data
 - **Outcome**: post build characterization data
- Analytics/learning tools to extract actionable information from that data
- Pathway to feed this info back to design/fab. process





3D Framework & Analytics



- Combine/register **planning**, **execution**, & **characterization** data sets, model outputs
- Challenges:
 - Range of data modalities
 - Disparate spatial and temporal scales
 - Large datasets: $\geq 1\text{TB}$ per build
- *SIMPL*: open-source software library for dynamic, hierarchical management of spatial data
- *DREAM.3D*: extensible tool suite for analytics of the internal state of materials, built on SIMPL

Michael Groeber: AFRL

Mike Jackson, Sean Donegan: BlueQuartz

<http://dream3d.bluequartz.net/>

From data to actionable information

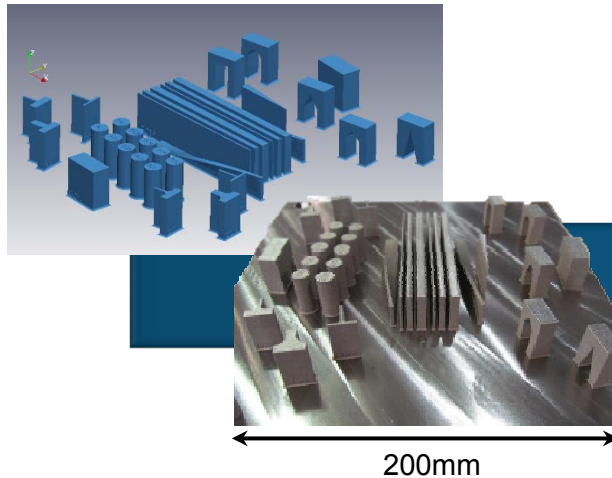




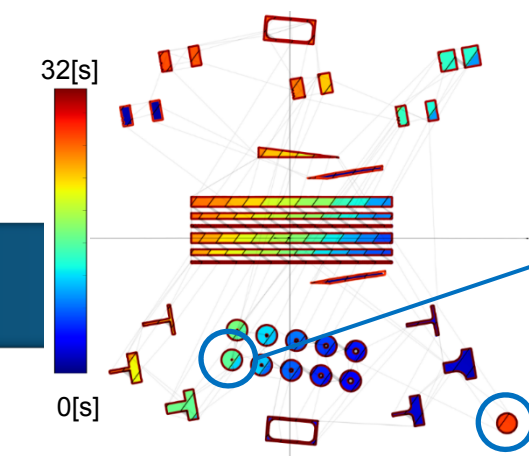
Example Analytics Pathway



CAD Geometry

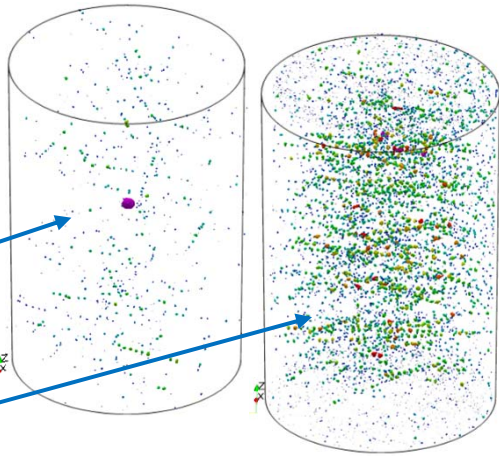


Energy Source Position & Properties

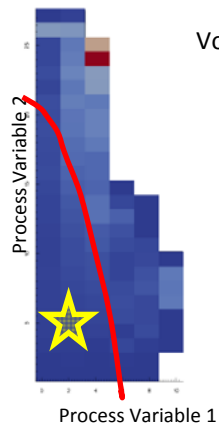


Experiments w/ T. Spears, J. Gockel GE Aviation
EOS M280 w/ Sigma Labs PrintRite3D

Post-Build Defect Characterization



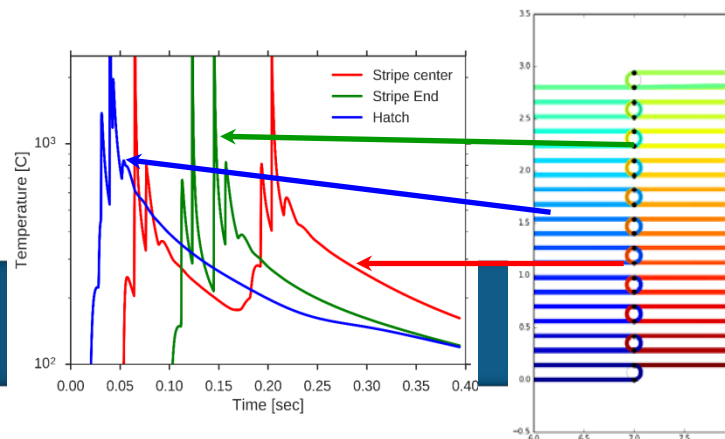
Generate Processing-Structure Maps



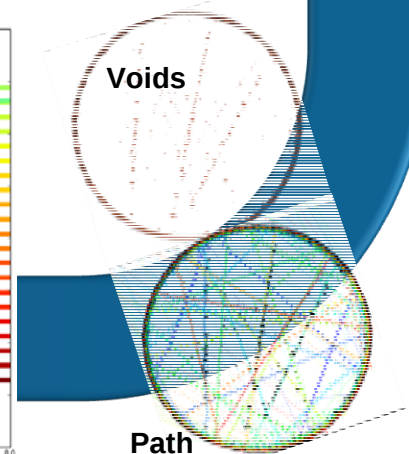
Void V_f

Select attributes of the
Temp vs. Time history
which are unique to void
voxels.

Generate Loc. Specific Temp vs. Time



Register/Align data





Open Questions



- What are sufficient *reduced order representations* of the local processing state?
 - Brute force: one (small) part has 10^8 location specific histories with 10^7 entries each
 - Opportunities for: intelligent/sparse sampling, signal processing techniques, symbolic aggregate approximation, genomics, ...
- How do we establish *which features* of the spatially varying energy input or thermal histories are *relevant* to particular micro and defect structures?
 - Combination of existing processing knowledge/experience with learning techniques
 - Opportunities for: dimensionality reduction, correlation analysis, PCA, CCA, topological data analysis, ...
- How to describe the spatial component of the correlations
 - Describe continuous variation in manageable number of 'zones'
 - Clustering techniques, spatial statistics,
- Given answers to the above, how do we suggest *new* processing pathways that yield desirable spatial variation in processing state/history?



Acknowledgements



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